



INFORMATION DISCLOSURE STATEMENT

(Use several sheets if necessary)

ATTY. DOCKET NO.

IO-1002-US

SERIAL NO.

09/867,286

APPLICANT

Ried et al.

FILING DATE

May 29, 2001

GROUP

2856

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
HR	AA	4,574,327	03/04/86	Wilner	361	283	
HR	AB	4,930,042	05/29/90	Wiegand et al.	361	280	
	AC						
	AD						
	AE						
	AF						
	AG						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	PUBL. DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
	AH							
	AI							
	AJ							

OTHER DISCLOSURES (Including Author, Title, Date, Pertinent Pages of Publication, Etc.)

HR	AK	"Single Crystal Silicon Microstructures Using Trench Isolation", by U. Sridhar, C. H. Lau, Y. B. Miao, K. S. Tan, P. D. Foo, J. J. Liu, K. Sooriakumar, Y. H. Loh, P. John, A. T. Lay Har, A. Austin, C. C. Lai and J. Bergstrom; Transducer '99; June 7-10, 1999; pp. 258-261.						
	AL							
	AM							

EXAMINER

Helen Kude

DATE CONSIDERED

3/9/03

*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next comment to applicant